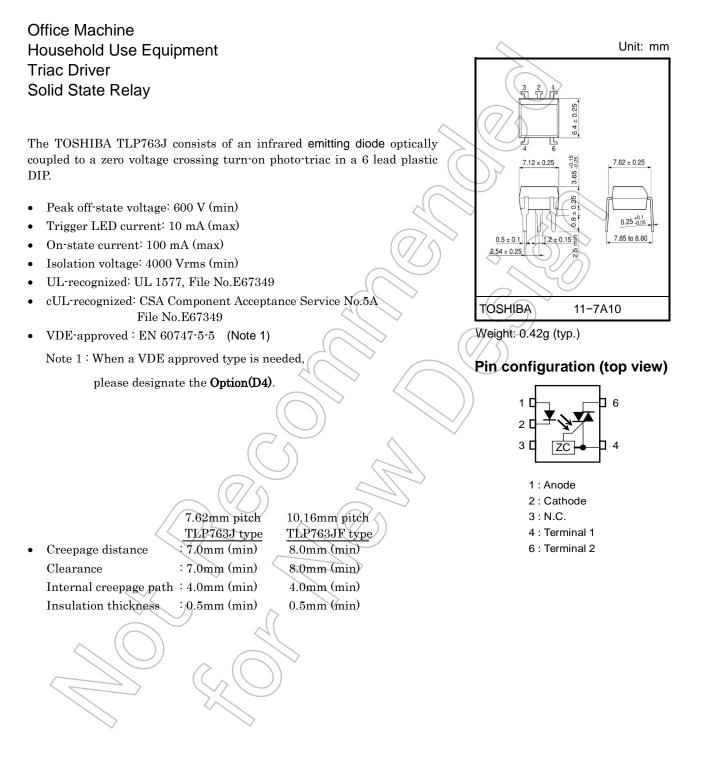
## TOSHIBA

TOSHIBA Photocoupler IRED & Photo-Triac

# TLP763J



#### Absolute Maximum Ratings (Ta = 25°C)

Characteristic			Symbol	Rating	Unit	
	Forward current		lF	50	mA	
	Forward current derating (Ta ≥ 53°C)		ΔI <sub>F</sub> /°C	-0.7	mA/°C	
	Peak forward current (100 µs pulse, 100 pps)		IFP	1	A	
LED	Reverse voltage		VR	5	v d	
	Diode power dissipation		PD	100	mW	$\sum r$
	Diode power dissipation derating (Ta ≥ 53°C)		∆P <sub>D</sub> /°C	-1.4	mW/°C	
	Junction temperature		Tj	125	(°C	)
	Off-state output terminal voltage		Vdrm	600	×	
	On-state RMS current	Ta = 25°C		100	$\bigcirc$	
Detector		Ta = 70°C	IT(RMS)	50	mA	
	On–state current derating (Ta ≥ 25°C)		ΔI <sub>T</sub> /°C	-1,1	mA/°C	
	Peak on-state current (100µs pulse, 120pps)		ITP	2	А	$\langle \mathcal{D} \rangle$
	Peak non-repetitive surge current (Pw = 10 ms)		Ітѕм	1.2	A	RO -
	Output power dissipation		Po	300	m₩	
	Output power dissipation derating (Ta $\ge$ 25°C)		ΔP₀/°C	-3.0	mW <i>L</i> °C	))
	Junction temperature		(Jj	115	7.0	
Storage temperature range		Tstg	-55 to 125	(°¢)		
Operating temperature range		Topr	-40 to 100	°C		
Lead soldering temperature (10 s)		T <sub>sol</sub>	260	) °C		
Isolatic	on voltage (AC, 60 s, R.H.≤ 60 %)		BVs	4000	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

#### **Recommended Operating Conditions**

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	VAC	_	_	240	Vac
Forward current	١ <sub>F</sub>	15	20	25	mA
Peak on-state current	I <sub>TP</sub>	_	_	1	А
Operating temperature	T <sub>opr</sub>	-25	_	85	°C

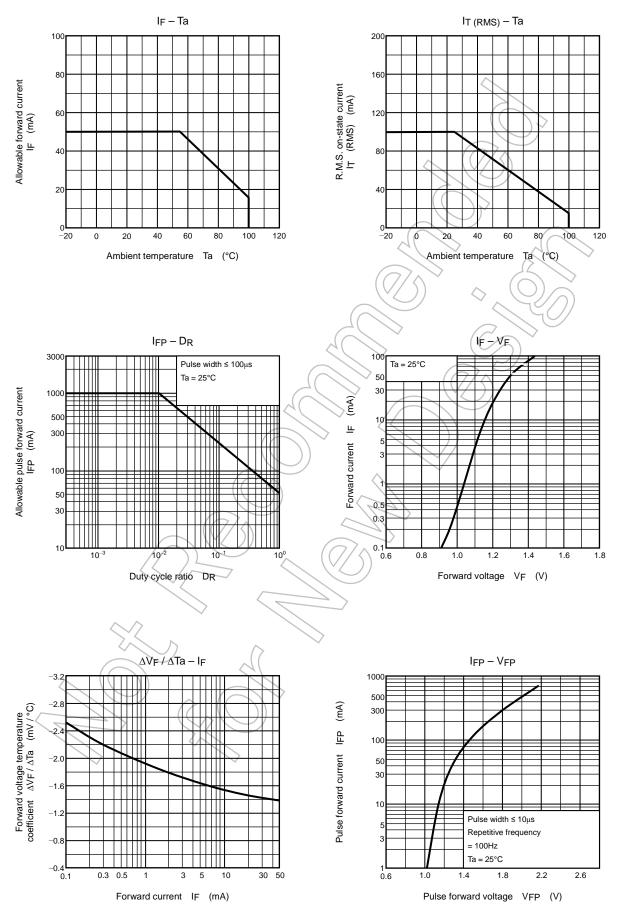
Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

#### **Electrical Characteristics (Ta = 25°C)**

	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
LED	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
	Reverse current	IR	V <sub>R</sub> = 5 V	_	_	10	μA
	Capacitance	Ст	VF = 0 V, f = 1 MHz	/	30	_	pF
Detector	Peak off-state current	Idrm	VDRM = 600 V	$\langle \rangle$	10	1000	nA
	Peak on-state voltage	V <sub>TM</sub>	I <sub>TM</sub> = 100 mA	$\langle \cdot \rangle$	) 1.7	3.0	V
	Holding current	Ін	(7)	$\sum_{k}$	0.6	_	mA
	Critical rate of rise of off-state voltage	dv / dt	Vin = 240 V, Ta = 85 °C	2	500	_	V/µs
	Critical rate of rise of commutating voltage	dv / dt (c)	Vin = 60Vrms , IT = 15 mA	_	0.2	_	V/µs

### Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Trigger LED current	IFT	V <sub>T</sub> = 6 V	$\sim$		10	mA
Inhibit voltage	VIH	IF = rated IFT		_	50	V
Leakage in inhibited state	Чн	IF = rated IFT VT = Rated VDRM	2	200	600	μA
Capacitance (input to output)	Cs	V <sub>S</sub> = 0 V, f = 1 MHz	/ _	0.8	_	pF
Isolation resistance	Rs	V <sub>S</sub> = 500 V, R.H. ≤ 60 %,	1×10 <sup>12</sup>	10 <sup>14</sup>	_	Ω
Isolation voltage	BVS	AC, 60 s	4000	—		Vrms



NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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